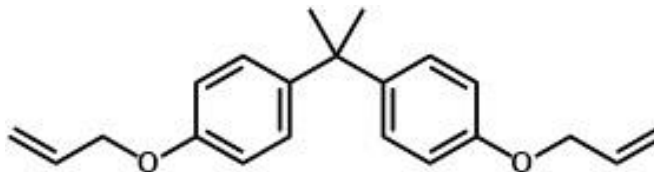


BIMAX® DAEBPA

Diallyl ether bisphenol A
CAS No. 3739-67-1
EINECS No. 2231233



Applications

This material is used in a variety of high technology applications including epoxidized adhesives for semiconductor chips, photoresists, tough impact resistant prepregs, and moldings with high breaking toughness for fiber reinforced structures. It is used in composites with high heat, water, and chemical resistance. Optical grade available upon request.

Typical Properties

Purity, %	> 92
Color, APHA	< 300 (optical grade < 50)
Moisture, %	< 0.1

Physical Properties

Appearance	clear liquid
Molecular weight	308.4 g/mol
Refractive index, 25°C	1.563
Solubility in water, %	< 0.1

Packaging

5-gallon poly pail, containing 18 kg
55-gallon poly drums, containing 200 kg

Storage and Handling

Store in a cool, dry place at temperatures below 32°C. Wear goggles and gloves. Eye and skin contact, as well as inhalation, should be avoided. If contact occurs, wash affected area immediately with cold water. Consult the Safety Data Sheet.

This information is presented for your consideration in the belief that it is accurate and reliable; however, Bimax makes no guarantees or warranty, either expressed or implied, of the accuracy or the completeness of this information. The information in this data sheet is designed only as a guidance for safe handling, storage and use of the substance. It is not a specification, nor does it guarantee any specific properties. All chemicals should be handled only by competent personnel, within a controlled environment. Individuals receiving this information are expected to use their own judgment in determining the relevancy for a particular circumstance. Accordingly, Bimax will not be responsible for damages of any kind resulting from the use of, or reliance upon, such information.